

## 7A, 650V N-CHANNEL MOSFET

### GENERAL DESCRIPTION

These N-Channel enhancement mode power field effect transistors are produced using Hi-semicon's proprietary, planar stripe, DMOS technology.

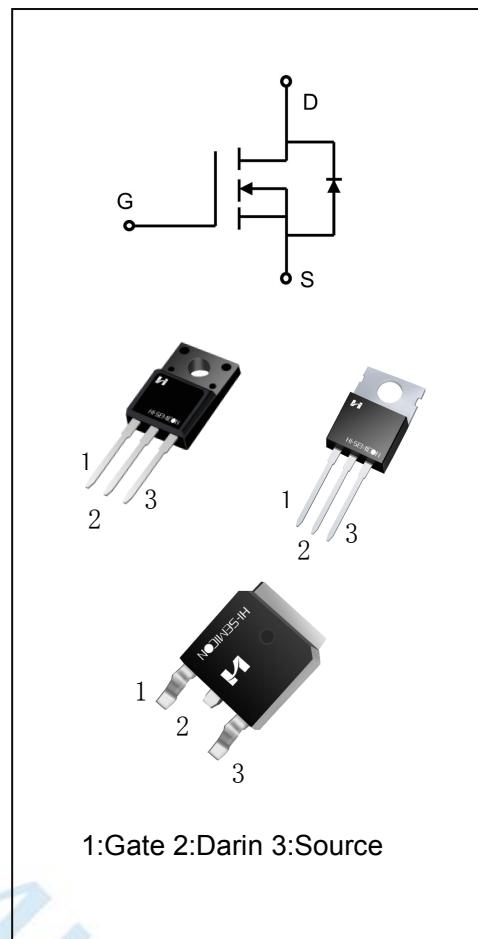
This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction, electronic lamp ballasts based on half bridge topology.

### Features

- ◆  $V_{DS(V)}=650V$ ,  $I_D=7A$
- ◆  $R_{DS(ON)}$   
TYP:  $1.1\Omega @ V_{GS}=10V$   $I_D=3.5A$   
MAX:  $1.4\Omega$

### Applications

- ◆ Power factor correction (PFC)
- ◆ Switched mode power supplies (SMPS)
- ◆ Uninterruptible power supply (UPS)
- ◆ LED lighting power



### ORDERING INFORMATION

Part No.	Package	Marking	Material	Packing
SFF7N65E	TO-220F-3L	SFF7N65E	Pb Free	Tube
SFP7N65E	TO-220-3L	SFP7N65E	Pb Free	Tube
SFD7N65E	TO-252-2L	SFD7N65E	Pb Free	Reel

**ABSOLUTE MAXIMUM RATINGS (T<sub>J</sub>=25°C unless otherwise noted)**

Characteristics	Symbol	Ratings			Unit
		SFF7N65E	SFP7N65E	SFD7N65E	
Drain-Source Voltage	V <sub>DS</sub>	650			V
Gate-Source Voltage	V <sub>GS</sub>	±30			V
Drain Current	T <sub>C</sub> = 25°C	I <sub>D</sub>	7.0		A
	T <sub>C</sub> = 100°C		5.6		
Drain Current Pulsed (Note 1)	I <sub>DM</sub>	28			A
Power Dissipation(T <sub>C</sub> =25°C) -Derate above 25°C	P <sub>D</sub>	34	80	46	W
		0.28	1.25	0.39	W/°C
Single Pulsed Avalanche Energy (Note 2)	E <sub>AS</sub>	425			mJ
Operation Junction Temperature Range	T <sub>J</sub>	-55~+150			°C
Storage Temperature Range	T <sub>stg</sub>	-55~+150			°C
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	TL	300			°C

**THERMAL CHARACTERISTICS**

Characteristics	Symbol	MAX			Unit
		SFF7N65E	SFP7N65E	SFD7N65E	
Thermal Resistance, Junction-to-Case	R <sub>θJC</sub>	3.5	1.8	2.5	°C/W
Thermal Resistance, Junction-to-Ambient	R <sub>θJA</sub>	62.5	62.5	62.5	°C/W

**ELECTRICAL CHARACTERISTICS**

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
<b>Off Characteristics</b>						
Drain -Source Breakdown Voltage	B <sub>VDSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	650	700	--	V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =650V, V <sub>GS</sub> =0V	--	3.3	100	nA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =30V, V <sub>DS</sub> =0V	--	3.4	100	nA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =-30V, V <sub>DS</sub> =0V	--	-2.1	-100	nA
<b>On Characteristics</b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> =250μA	2	2.9	4.0	V
Static Drain- Source On State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =1A	--	1.0	1.38	Ω
		V <sub>GS</sub> =10V, I <sub>D</sub> =3.5A	--	1.1	1.4	Ω
<b>Dynamic Characteristics</b>						
Gate Resistance	R <sub>g</sub>	V <sub>GS</sub> =0V; f=1.0MHZ	1	2.2	10	Ω
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =25V	--	1100	--	pF
Output Capacitance	C <sub>oss</sub>		--	90.5	--	
Reverse Transfer Capacitance	C <sub>rss</sub>		--	4.9	--	
<b>Switching Characteristics</b>						
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =325V; V <sub>GS</sub> =10V R <sub>G</sub> =10Ω; I <sub>D</sub> =7A (Note 3.4)	--	11.5	--	ns
Turn-on Rise Time	t <sub>r</sub>		--	26.3	--	

Turn-off Delay Time	$t_{d(\text{off})}$	$V_{DD}=325V; V_{GS}=10V$ $R_G=10\Omega; I_D=7A$ (Note 3.4)	--	39.2	--	ns
Turn-off Fall Time	$t_f$		--	31.5	--	
Total Gate Charge	$Q_g$	$V_{DS}=520V, I_D=7A$ $V_{GS}=10V$ (Note 3.4)	--	15.5	--	nc
Gate-Source Charge	$Q_{gs}$		--	4.3	--	
Gate-Drain Charge	$Q_{gd}$		--	6.6	--	

## SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

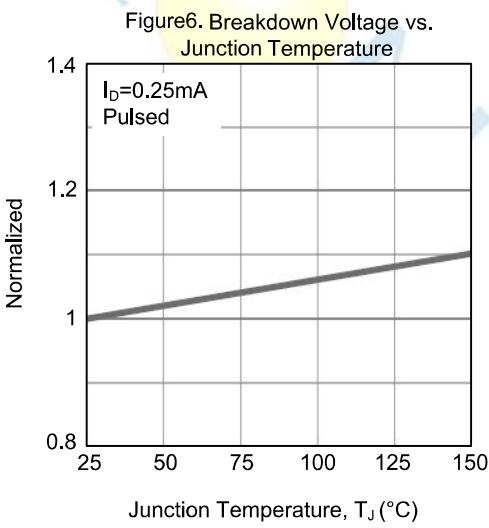
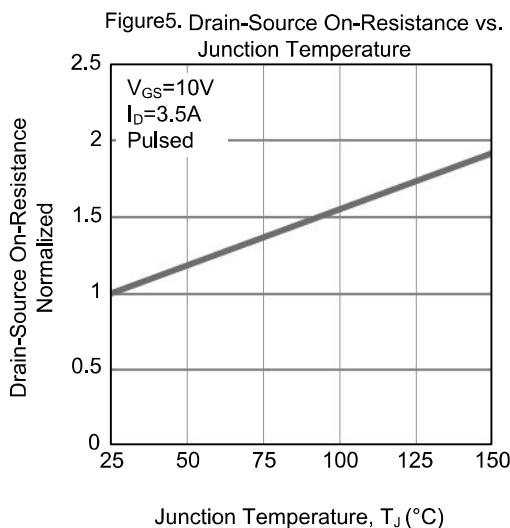
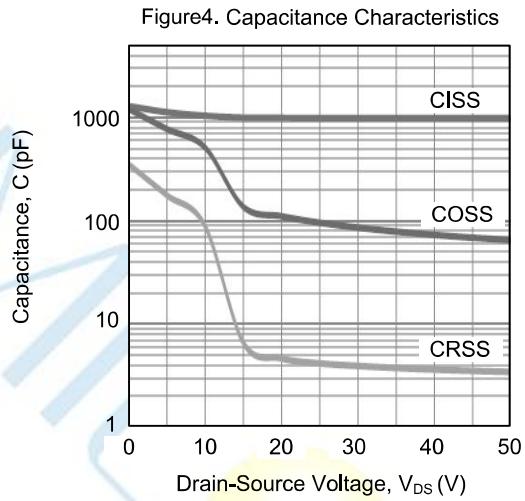
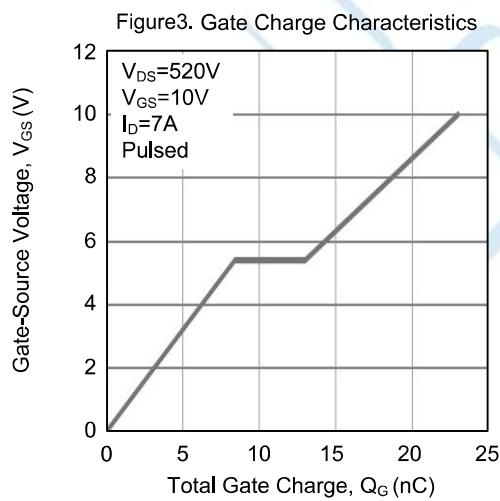
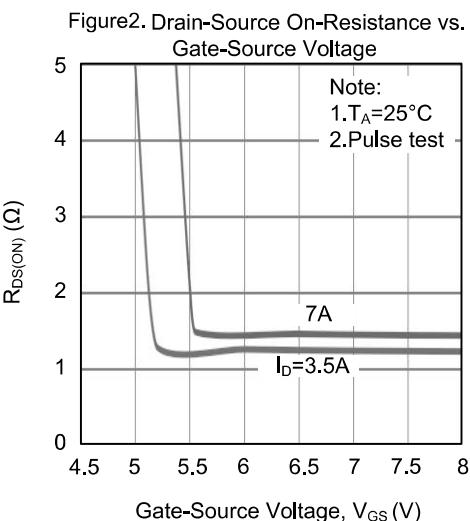
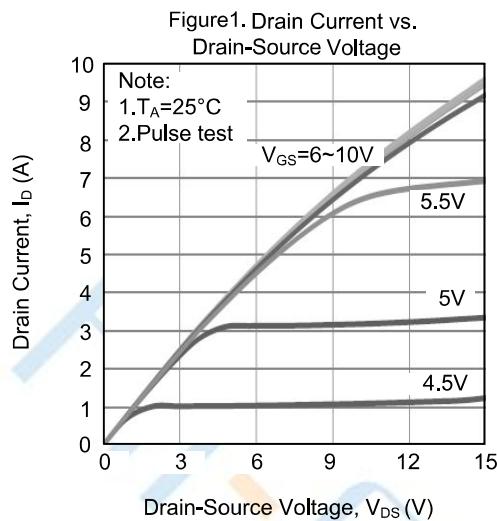
Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	$I_S$	Integral Reverse P-N Junction Diode in the MOSFET	--	--	7	A
Pulsed Source Current	$I_{SM}$		--	--	28	
Diode Forward Voltage	$V_{SD}$	$I_S=7A, V_{GS}=0V$	--	0.82	1.2	V
Reverse Recovery Time	$T_{rr}$	$I_F=7A, V_R=520V,$ $dI/dt=100A/\mu S$	--	521	--	ns
Reverse Recovery Charge	$Q_{rr}$		--	3.6	--	$\mu C$

1. Pulse width limited by maximum junction temperature

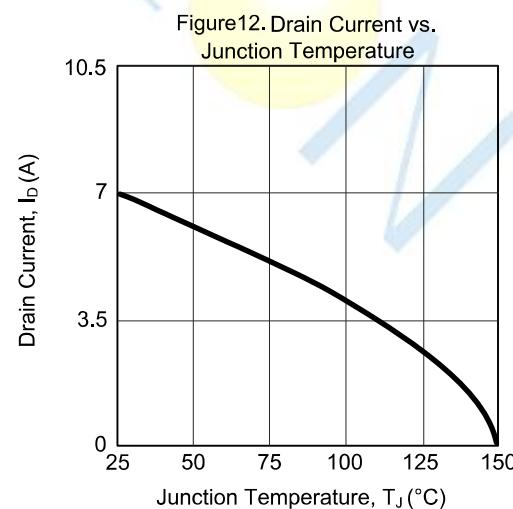
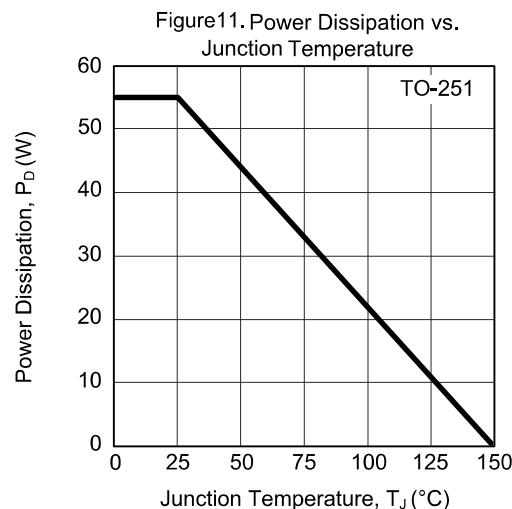
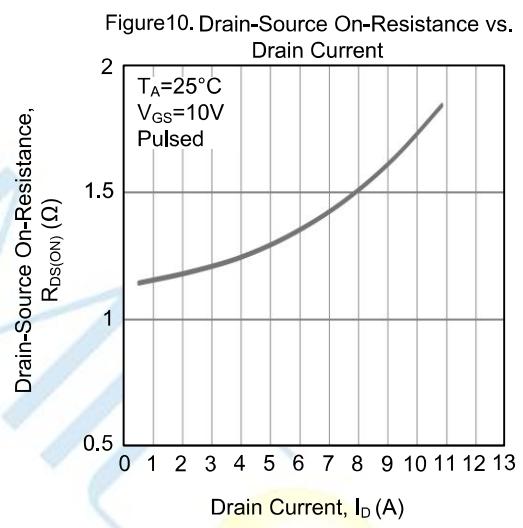
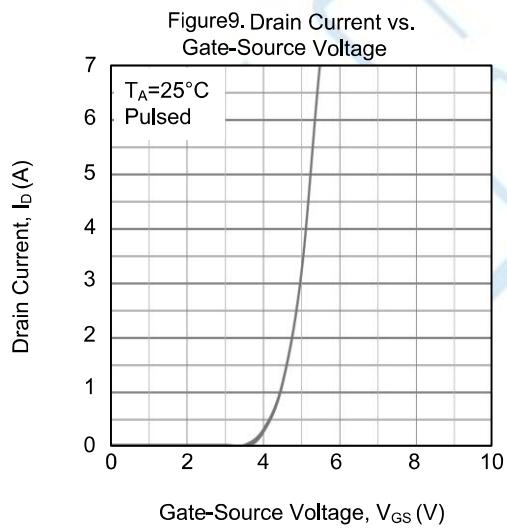
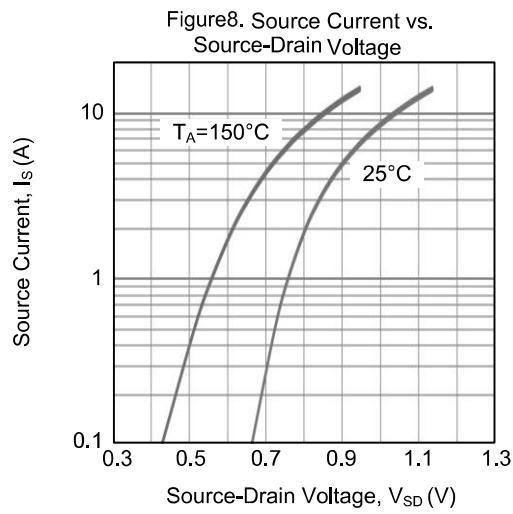
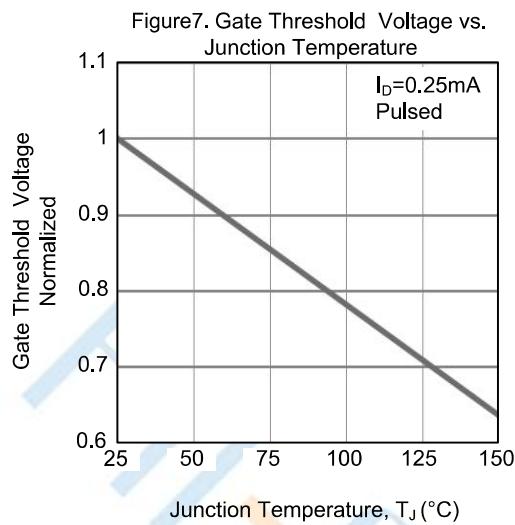
2. L=20mH,  $I_{AS}=6A$ ,  $V_{DD}=100V$ ,  $V_G=10V$ ,  $R_G=25\Omega$ , starting  $T_J=25^\circ C$ 3. Pulse Test: Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$ 

4. Essentially independent of operating temperature

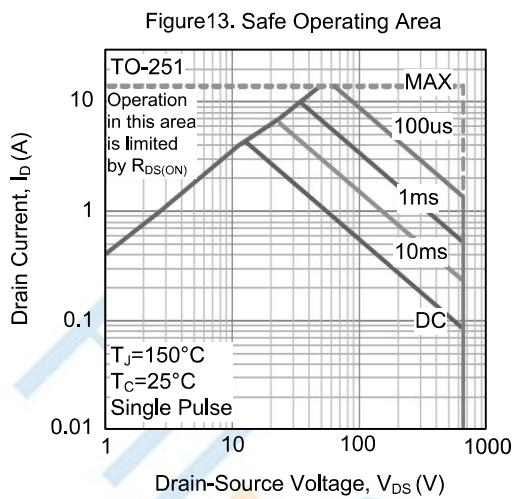
## Typical Performance Characteristics



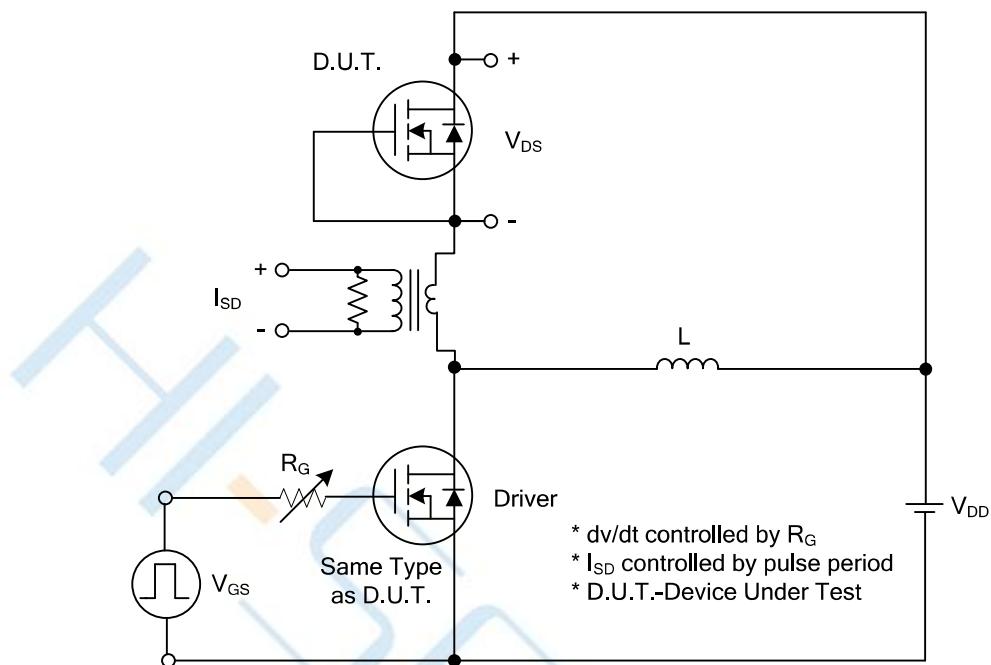
## Typical Performance Characteristics



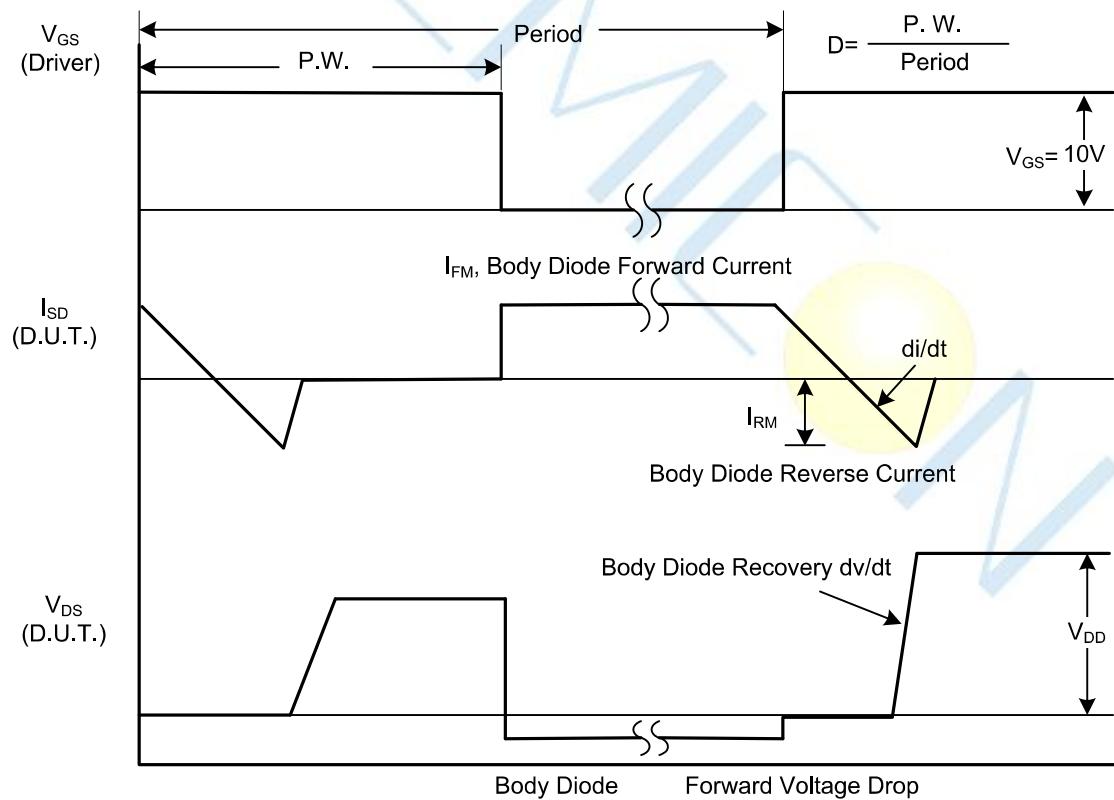
## Typical Performance Characteristics



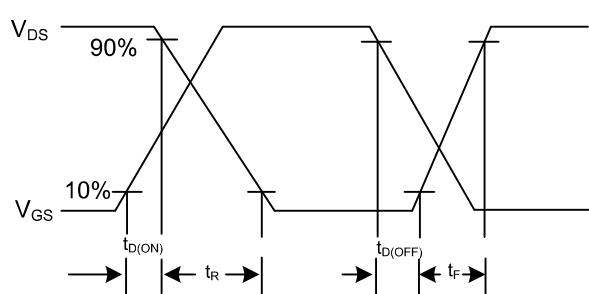
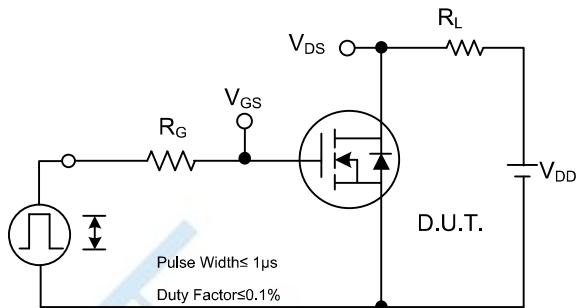
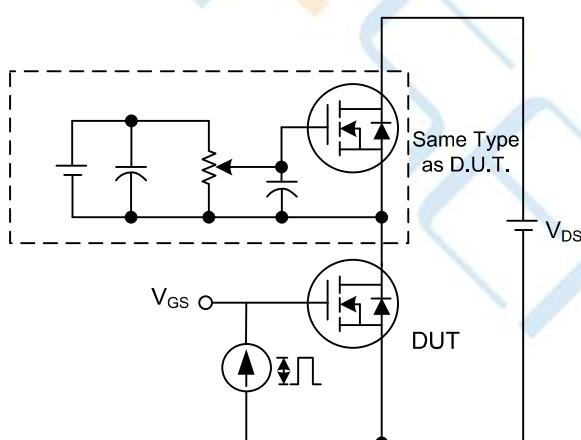
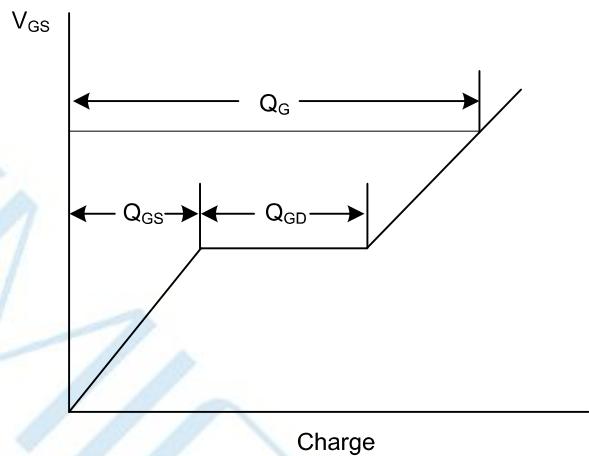
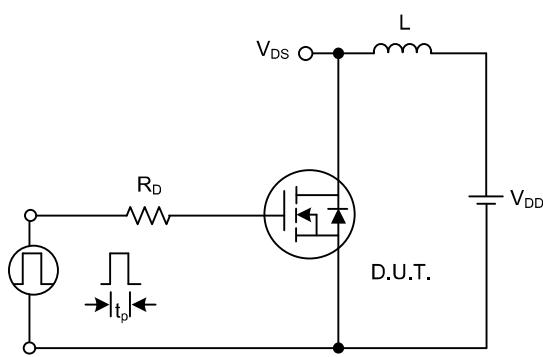
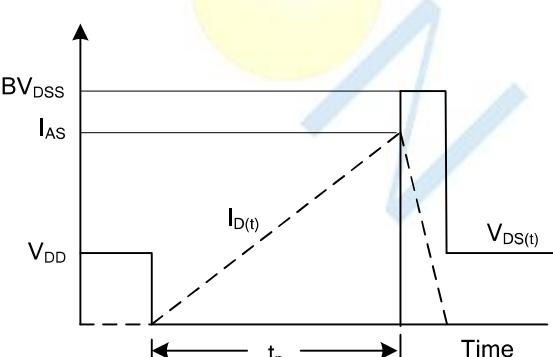
## Test Circuit



Peak Diode Recovery dv/dt Test Circuit

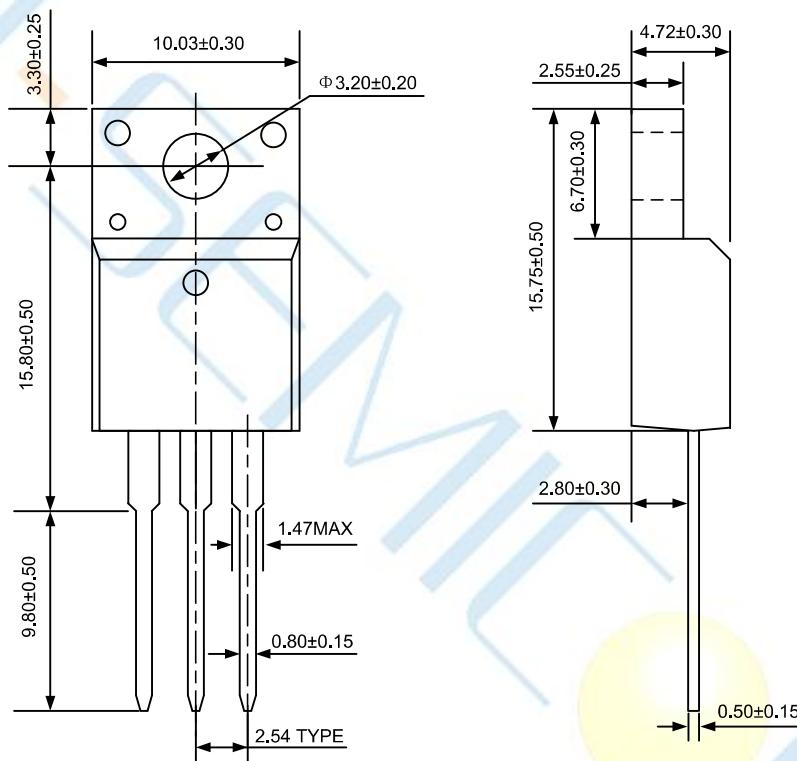


Peak Diode Recovery dv/dt Waveforms

**Test Circuit****Switching Test Circuit****Switching Waveforms****Gate Charge Test Circuit****Gate Charge Waveform****Unclamped Inductive Switching Test Circuit****Unclamped Inductive Switching Waveforms**

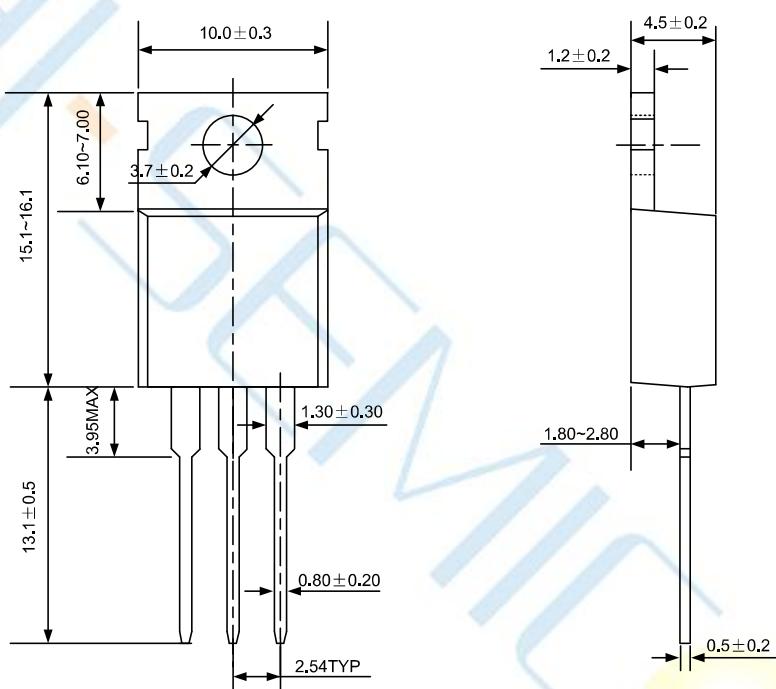
## Package Dimensions of TO-220F-3L

Unit:mm



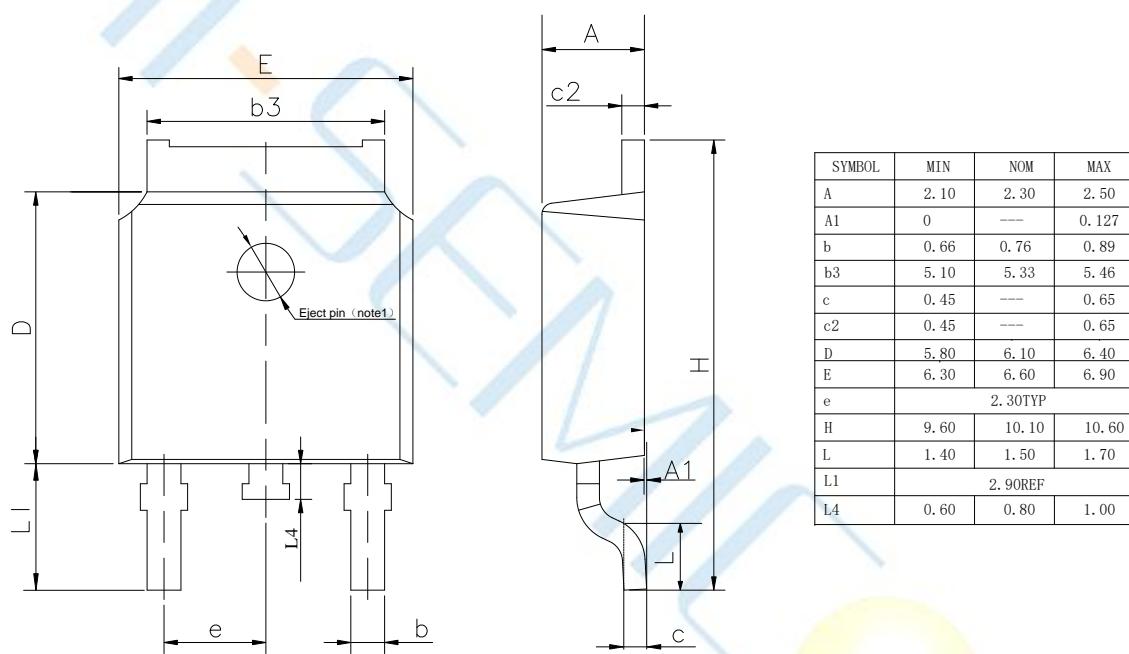
## Package Dimensions of TO-220-3L

Unit:mm



## Package Dimensions of TO-252-2L

Unit:mm



**Disclaimer:**

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